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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR $\mu PA651TT$

# P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### **DESCRIPTION**

The  $\mu PA651TT$  is a switching device, which can be driven directly by a 1.8 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

#### **FEATURES**

- 1.8 V drive available
- Low on-state resistance

RDS(on)1 = 69 m $\Omega$  MAX. (VGS = -4.5 V, ID = -2.5 A)

RDS(on)2 = 88 m $\Omega$  MAX. (VGS = -2.5 V, ID = -2.5 A)

 $R_{DS(on)3} = 142 \text{ m}\Omega \text{ MAX.} (V_{GS} = -1.8 \text{ V}, I_{D} = -1.5 \text{ A})$ 

#### ORDERING INFORMATION

PART NUMBER	PACKAGE			
μPA651TT	6pinWSOF (1620)			

Marking: WE

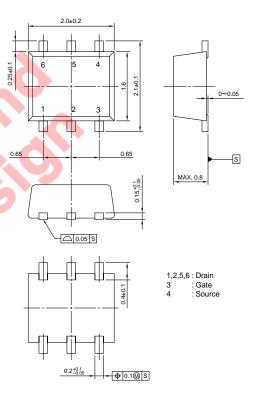
#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-20	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓8.0	V
Drain Current (DC) (T <sub>A</sub> = 25°C)	ID(DC)	∓5.0	Α
Drain Current (pulse) Note1	D(pulse)	∓20	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	0.2	W
Total Power Dissipation (T <sub>A</sub> = 25°C) Note2	P <sub>T2</sub>	1.4	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

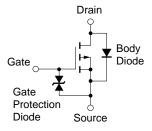
**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

**2.** Mounted on FR-4 board,  $t \le 5$  sec.

#### PACKAGE DRAWING (Unit: mm)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

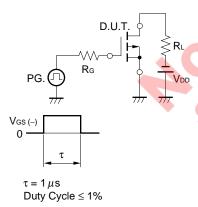
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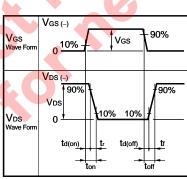


**ELECTRICAL CHARACTERISTICS (TA = 25°C)** 

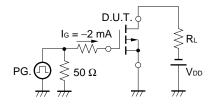
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	lgss	$V_{GS} = \overline{+}8.0 \text{ V}, V_{DS} = 0 \text{ V}$			∓10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -1.0 \text{ mA}$	-0.45		-1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$	4.0			S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -4.5 \text{ V}, I_{D} = -2.5 \text{ A}$		55	69	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -2.5 A		66	88	mΩ
	RDS(on)3	V <sub>GS</sub> = −1.8 V, I <sub>D</sub> = −1.5 A		85	142	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = −10 V		600		pF
Output Capacitance	Coss	V <sub>G</sub> S = 0 V		120		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		75		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = −10 V, I <sub>D</sub> = −2.5 A		45		ns
Rise Time	tr	Vgs = -4.0 V		200		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		435		ns
Fall Time	tf			345		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = −16 V		5.5		nC
Gate to Source Charge	Qgs	Vgs = -4.0 V		1.2		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -5.0 A		2.1		nC
Body Diode Forward Voltage	V <sub>F(S-D)</sub>	IF = 5.0 A, VGS = 0 V		0.94		V

#### **TEST CIRCUIT 1 SWITCHING TIME**



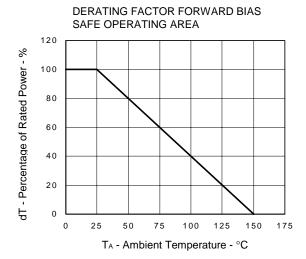


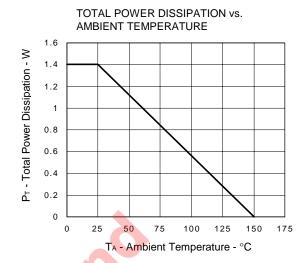
#### **TEST CIRCUIT 2 GATE CHARGE**

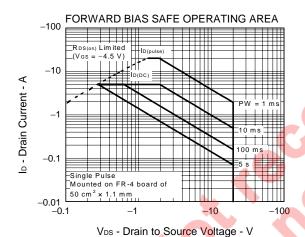


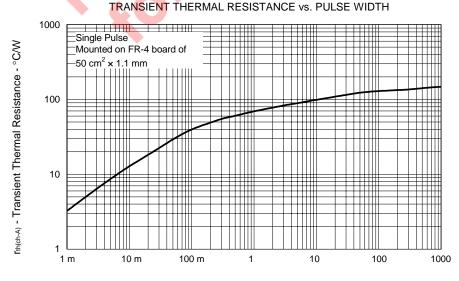


#### TYPICAL CHARACTERISTICS (TA = 25°C)



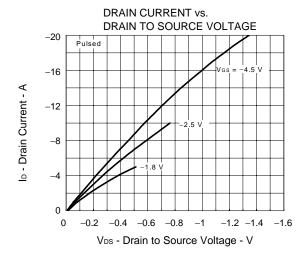


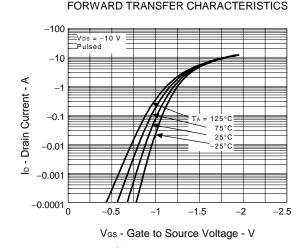


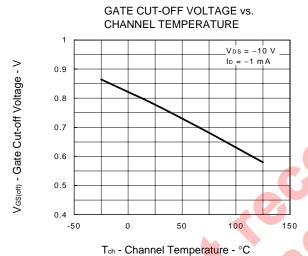


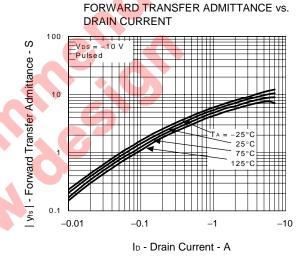
PW - Pulse Width - s

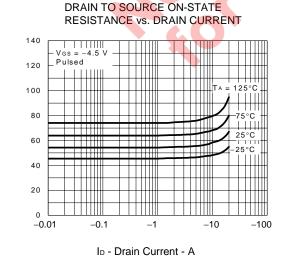
3

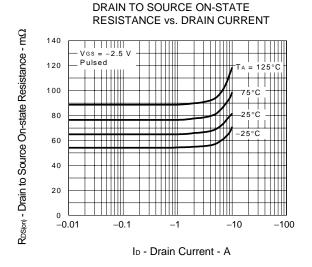










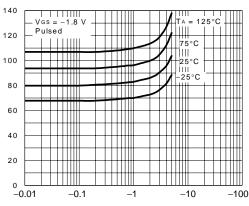


Ros(on) - Drain to Source On-state Resistance - mΩ



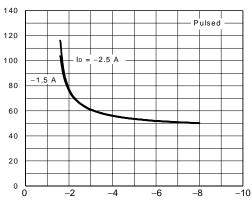
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

## DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



ID - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



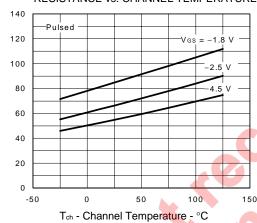
 $\mathsf{R}_{\mathsf{DS}(m)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

Coss, Crss - Capacitance - pF

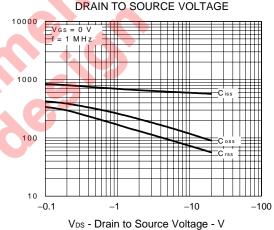
Ves - Gate to Source Voltage - V

V<sub>GS</sub> - Gate to Source Voltage - V

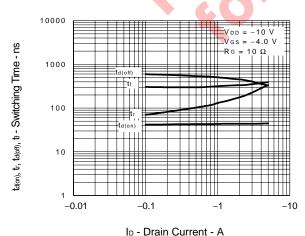
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



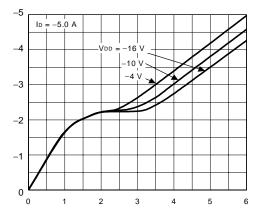
CAPACITANCE vs.



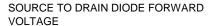
SWITCHING CHARACTERISTICS

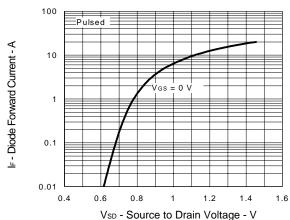


DYNAMIC INPUT/OUTPUT CHARACTERISTICS



Q<sub>G</sub> - Gate Charge - nC







[MEMO]



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